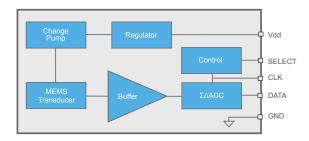
MULTIMODE DIGITAL BOTTOM PORT SISONIC™ MICROPHONE

The SPH0644LM4H-1 is a miniature, high-performance, low power, bottom port silicon digital microphone with a single bit PDM output. Using Knowles' proven high performance SiSonic[™] MEMS technology, the SPH0644LM4H-1 consists of an acoustic sensor, a low noise input buffer, and a sigma-delta modulator. These devices are suitable for applications such as cellphones, smart phones, laptop computers, sensors, digital still cameras, portable music recorders, and other portable electronic devices where excellent wideband audio performance and RF immunity are required. In addition, the SPH0644LM4H-1 offers multiple performance modes.



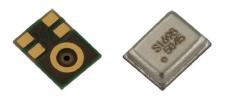
ABSOLUTE MAXIMUM RATINGS

Table 1: Absolute Maximum Ratings

| Parameter | Absolute Maximum Rating | Units |
|----------------------------|-----------------------------|-------|
| Vdd, DATA to Ground | -0.3, +5.0 | V |
| CLOCK, SELECT to Ground | -0.3, +5.0 | V |
| Input Current | ±5 | mA |
| Short Circuit to/from DATA | Indefinite to Ground or Vdd | sec |
| Temperature | -40 to +100 | °C |

Stresses exceeding these "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications" is not implied. Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

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PRODUCT FEATURES

- Low Distortion /High AOP
- High SNR
- Low Current Consumption in
 Low-Power Mode
- Flat Frequency Response
- High Drive Capability
- RF Shielded
- Bottom Port
- Sensitivity Matching
- Supports Dual Multiplexed Channels
- Multiple Performance Modes (Sleep, Low-Power, Normal)
- Ultra-Stable Performance
- Standard SMD Reflow
- Omnidirectional
- LGA Package

TYPICAL APPLICATIONS

- Portable electronics
- Cellphones
- Laptop Computers
- Tablets
- Digital Still Cameras
- Portable Music Recorders





ACOUSTIC & ELECTRICAL SPECIFICATIONS¹

Table 2: General Microphone Specifications

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Tedge ≤ 3ns, unless otherwise indicated

| Parameter | Symbol | Conditions | Min | Тур | Max | Units |
|---------------------------------|--------|--|---------------|---------------|-------|-------|
| Supply Voltage | Vdd | | 1.6 | 1.8 | 3.6 | V |
| DC Output | | Fullscale = ±100 | - | 0 | - | % FS |
| Directivity | | | Omnidirectio | onal | | |
| Polarity | | Increasing sound pressure | Increasing d | ensity of 1's | | |
| Data Format | | | 1/2 Cycle PDN | 1 | | |
| Sensitivity Drop | | Vdd(min) ≤ Vdd ≤ Vdd(max) | - | - | ±0.25 | dB |
| Clock Input Capacitance | Cin | | - | 5 | - | pF |
| SELECT (high) | | | Vdd-0.2 | - | 3.6 | V |
| SELECT (low) | | | -0.3 | - | 0.2 | V |
| SELECT Sample Time | | After power up, Vdd = Vdd(min) | - | 50 | - | ms |
| Short Circuit Current | lsc | Grounded DATA pin | 1 | - | 20 | mA |
| Output Load | Cload | | - | - | 140 | pF |
| Fall-asleep Time ^{2,3} | | Fclock < 250 KHz | - | - | 10 | ms |
| Wake-up Time ^{2,4} | | Fclock ≥ 500 KHz | - | - | 35 | ms |
| Startup Time ² | | Powered Down \rightarrow Active Mode | - | - | 50 | ms |
| Mode-Change Time ² | | Audio is muted | - | - | 16 | ms |

¹ Sensitivity and Supply Current are 100% tested.

² Valid microphones states are: Powered Down Mode (mic off), Sleep Mode (low current, DATA = high-Z, fast startup), Low-Power Mode (low clock speed) and Normal Mode.

³ Time from Fclock < 250 kHz to Isleep specification is met when transitioning from Active Mode to Sleep Mode.

⁴ Time from Fclock ≥ 500 kHz to all applicable specifications are met when transitioning from Sleep Mode to Active Mode.





Table 3: Normal Mode

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 2.4MHz (D.C. = 50%), Tedge ≤ 3ns, SELECT grounded, no load, unless otherwise indicated

| Parameter | Symbol | Conditions | Min | Тур | Мах | Units |
|------------------------------|--------|---|-----|-------|------|---------|
| | | Fclock = 1.536 MHz | - | 685 | 850 | |
| Supply Current ⁵ | Idd | Fclock = 2.4 MHz | - | 900 | 1100 | μA |
| | | Fclock = 3.072 MHz | - | 1130 | 1400 | |
| Sensitivity | S | 94 dB SPL @ 1 kHz | -38 | -37 | -36 | dBFS |
| Signal to Noise Ratio | SNR | 94 dB SPL @ 1 kHz, A-weighted | - | 65.5 | - | dB(A) |
| Total Harmonic Distortion | THD | 94 dB SPL @ 1 kHz | - | 0.2 | - | % |
| | | 1% THD @ 1 kHz, S = typ | - | 114.5 | - | dB SPL |
| Acoustic Overload Point | AOP | 10% THD @ 1 kHz, S = typ | - | 132.5 | - | dB SPL |
| Low Frequency Rolloff | LFRO | -3dB relative to 1 kHz | - | 35 | - | Hz |
| Power Supply Rejection Ratio | PSRR | 200 mVpp sinewave @ 1 kHz | - | 87 | - | dB V/FS |
| Power Supply Rejection | PSR+N | 200 mVpp 7/8 duty cycle rectangular waveform @ 217 Hz, A-weighted, BW = 20 kHz | - | -97 | - | dBFS(A) |

⁵ Idd varies with Cload according to: Δ Idd = 0.5*Vdd* Δ Cload*Fclock.

Table 4: Low-Power Mode

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 768kHz (D.C. = 50%), Tedge ≤ 3ns, SELECT grounded, no load, unless otherwise indicated

| Parameter | Symbol | Conditions | Min | Тур | Max | Units |
|------------------------------|--------|--|-----|-------|-----|---------|
| Supply Current ^₅ | Idd | | - | 255 | 320 | μΑ |
| Sensitivity | S | 94 dB SPL @ 1 kHz | -22 | -21 | -20 | dBFS |
| Signal to Noise Ratio | SNR | 94 dB SPL @ 1 kHz, A-weighted (BW = 8 kHz) | - | 64.5 | - | dB(A) |
| Total Harmonic Distortion | THD | 94 dB SPL @ 1 kHz | - | 0.2 | - | % |
| | | 1% THD @ 1 kHz, S = typ | | 113 | | dB SPL |
| Acoustic Overload Point | AOP | 10% THD @ 1 kHz, S = typ | - | 116.5 | - | dB SPL |
| Low Frequency Rolloff | LFRO | -3dB relative to 1 kHz | - | 35 | - | Hz |
| Power Supply Rejection Ratio | PSRR | 200 mVpp sinewave @ 1 kHz | - | 76 | - | dBV/FS |
| Power Supply Rejection | PSR+N | 200 mVpp 7/8 duty cycle rectangular waveform @ 217 Hz, A-weighted, BW = 8 kHz | - | -85 | - | dBFS(A) |

 5 Idd varies with Cload according to: ΔIdd = 0.5*Vdd* $\Delta Cload*Fclock.$





Table 5: Sleep Mode

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 250kHz (D.C. = 50%), Tedge ≤ 3ns, SELECT grounded, no load, unless otherwise indicated

| Parameter | Symbol | Conditions | Min | Тур | Max | Units |
|----------------|--------|------------------|-----|-----|-----|-------|
| Classe Comment | lalaan | Fclock = 0 Hz | - | 50 | - | |
| Sleep Current | Isleep | Fclock = 250 kHz | - | 54 | 80 | μΑ |

Table 6: Digital Interface

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Tedge ≤ 3ns, unless otherwise indicated

| Parameter | Symbol | Conditions | Min | Тур | Max | Units |
|--|--------------------|-------------------------|----------|-----|----------|-------|
| Logic Input High ⁶ | Vih | | 0.65xVdd | - | 3.6 | V |
| Logic Input Low ⁶ | Vil | | -0.3 | - | 0.35xVdd | V |
| Logic Output High ⁶ | Voh | I _{out} = 2 mA | Vdd-0.45 | - | Vdd | V |
| Logic Output Low ⁶ | Vol | I _{out} = 2 mA | 0 | - | 0.45 | V |
| Low→High Threshold ⁷ | VI-h | | - | - | 0.65xVdd | V |
| High→Low Threshold ⁷ | Vh-l | | 0.35xVdd | - | - | V |
| Hysteresis Width ⁷ | Vhyst | | 0.05xVdd | - | 0.20xVdd | V |
| | | Sleep Mode | 0 | - | 280 | |
| Clock Frequency ⁶ | Fclock | Low Power Mode | 500 | - | 1200 | kHz |
| | | Normal Mode | 1400 | - | 4800 | |
| | D.C. | Fclock < 3 MHz | 40 | 50 | 60 | 0/ |
| Clock Duty Cycle | ck Duty Cycle D.C. | Fclock ≥ 3 MHz | 48 | 50 | 52 | % |
| Delay Time to Data Line Driven ⁶ | Tdd | | 18 | - | 35 | ns |
| Delay Time to Valid Data ⁶ | Tdv | Max Cload | - | - | 100 | ns |
| Delay Time to High Z ^{6,8} | Tdz | | 5 | - | 16 | ns |

⁶ See Figure 1: Timing Diagram.

⁷ See Figure 2: Hysteresis Diagram.

⁸ Thold can be dependent on Cload.



MULTIMODE DIGITAL BOTTOM PORT SISONICTM MICROPHONE

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Figure 1: Timing Diagram

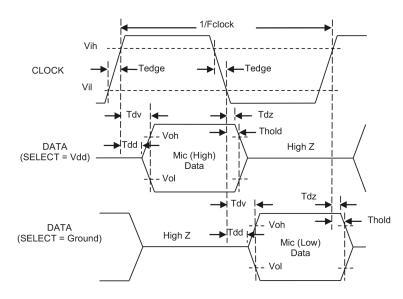


Figure 2: Hysteresis Diagram

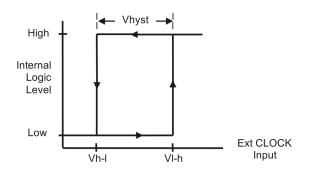


Figure 4: State Diagram

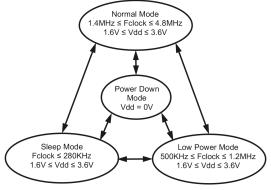
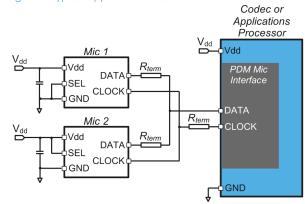


Figure 3: Typical Application Circuit



NOTES:

All Ground pins must be connected to ground. Bypass capacitors should be placed next to each Vdd pin for best performance.

Capacitors near the microphone should not contain Class 2 dielectrics due to their piezoelectric effect.

Detailed information on acoustic, mechanical, and system integration can be found in the latest SiSonic[™] Design Guide application note.

Table 7: SELECT Functionality

| Microphone | SELECT | Asserts DATA on | Latch DATA on |
|------------|--------|------------------|------------------|
| Mic (High) | Vdd | CLK rising edge | CLK falling edge |
| Mic (Low) | Ground | CLK falling edge | CLK rising edge |



MULTIMODE DIGITAL BOTTOM PORT SISONIC[™] MICROPHONE



PERFORMANCE CURVES

Test Conditions: 23 ±2°C, 55±20% R.H., Vdd=1.8 V, Fclock = 2.4MHz, SELECT grounded, no load, unless otherwise indicated

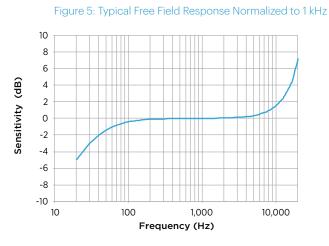


Figure 7: Typical Free Field Response Normalized to 1 kHz

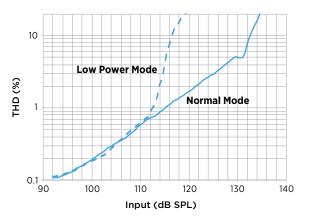


Figure 9: Typical THD vs Frequency

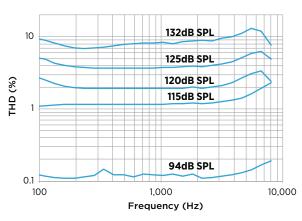


Figure 6: Typical PSRR

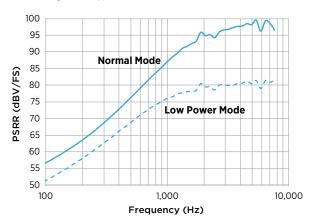


Figure 8: Typical Idd vs Vdd

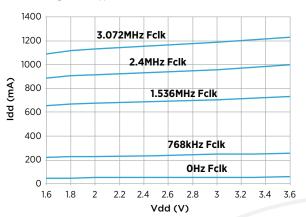
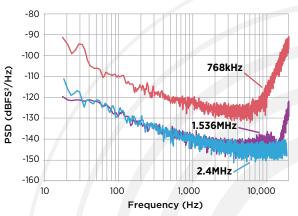
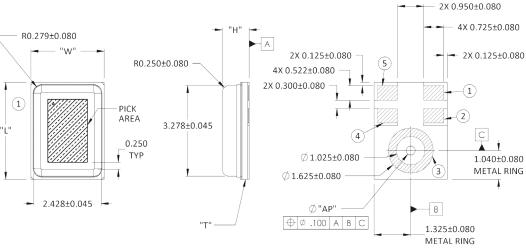


Figure 10: Noise Floor Power Spectral Density





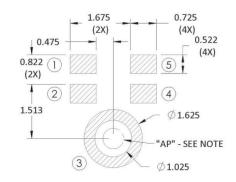
MECHANICAL SPECIFICATIONS



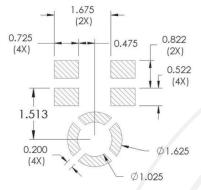
| Item | Dimension | Tolerance |
|--------------------|-----------|-----------|
| Length (L) | 3.50 | ±0.10 |
| Width (W) | 2.65 | ±0.10 |
| Height (H) | 0.98 | ±0.10 |
| Acoustic Port (AP) | Ø0.325 | ±0.05 |
| PCB Thickness (T) | 0.307 | ±0.05 |

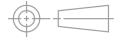
| Pin # | Pin Name | Туре | Description |
|-------|----------|---------------|---|
| 1 | DATA | Digital O | PDM Output |
| 2 | SELECT | Non-Digital I | Lo/Hi (L/R) Select Connect to Vdd or GND |
| 3 | GROUND | Power | Ground |
| 4 | CLOCK | Digital I | Clock Input |
| 5 | Vdd | Power | Power Supply. Pull low to turn off and do not leave floating. |

Example Land Pattern



Example Solder Stencil Pattern





NOTES:

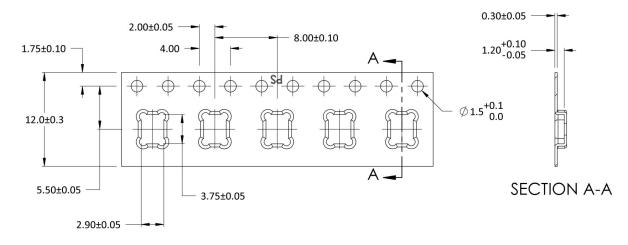
Pick Area only extends to 0.25 mm of any edge or hole unless otherwise specified. Dimensions are in millimeters unless otherwise specified. Tolerance is ±0.15mm unless otherwise specified.

Detailed information on AP size considerations can be found in the latest SiSonic™ Design Guide application note.

Further optimizations based on application should be performed.



PACKAGING & MARKING DETAIL



| Model Number | Suffix | Reel Diameter | Quantity Per Reel |
|---------------|--------|---------------|-------------------|
| SPH0644LM4H-1 | -8 | 13" | 5,900 |

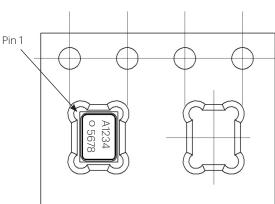
| Component | Surface Resistance (ohms) |
|--------------|------------------------------------|
| Reel | 10 ⁵ - 10 ⁹ |
| Carrier Tape | 10 ⁵ - 10 ⁹ |
| Cover Tape | 10 ⁴ - 10 ¹⁰ |

"o": orientation mark

- Alpha Character A:
 - "S": Knowles SiSonic™ Production
 - "E": Knowles Engineering Samples
 - "P": Knowles Prototype Samples

"12345678":

Unique Job Identification Number for product traceability



NOTES:

Dimensions are in millimeters unless otherwise specified.

Vacuum pickup only in the pick area indicated in Mechanical Specifications.

Tape & reel per EIA-481.

Labels applied directly to reel and external package.

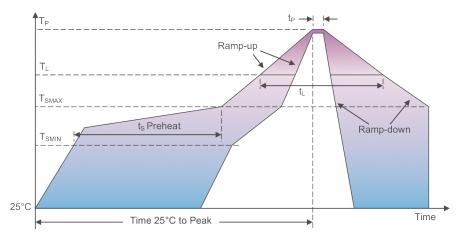
Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under

maximum environmental conditions of 30°C, 70% R.H.





RECOMMENDED REFLOW PROFILE



| Profile Feature | Pb-Free |
|---|----------------------------------|
| Average Ramp-up rate (TSMAX to TP) | 3°C/second max. |
| Preheat • Temperature Min (TSMIN) • Temperature Max (TSMAX) • Time (TSMIN to TSMAX) (tS) | 150°C 200°C 60-180 seconds |
| Time maintained above: • Temperature (TL) • Time (tL) | 217°C 60-150 seconds |
| Peak Temperature (TP) | 260°C |
| Time within 5°C of actual Peak Temperature (tP) | 20-40 seconds |
| Ramp-down rate (TP to TSMAX) | 6°C/second max |
| Time 25°C to Peak Temperature | 8 minutes max |

NOTES:

Based on IPC/JDEC J-STD-020 Revision C.

All temperatures refer to topside of the package, measured on the package body surface.

ADDITIONAL NOTES:

- (A) MSL (moisture sensitivity level) Class 1.
- (B) Maximum of 3 reflow cycles is recommended.
- (C) In order to minimize device damage:
 - Do not board wash or clean after the reflow process.
 - Do not brush board with or without solvents after the reflow process.
 - Do not directly expose to ultrasonic processing, welding, or cleaning.
 - Do not insert any object in port hole of device at any time.
 - Do not apply over 30 psi of air pressure into the port hole.
 - Do not pull a vacuum over port hole of the microphone.
 - Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.



MULTIMODE DIGITAL BOTTOM PORT SISONIC[™] MICROPHONE



MATERIALS STATEMENT

Meets the requirements of the European RoHS directive 2011/65/EC as amended.

Meets the requirements of the industry standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.

Product is Beryllium Free according to limits specified on the Knowles Hazardous Material List (HSL for Products).

Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in Annex A, B, and C of the "Montreal Protocol on Substances That Deplete the Ozone Layer."

RELIABILITY SPECIFICATIONS

| Test | Description | |
|---------------------------|--|--|
| Thermal Shock | 100 cycles of air-air thermal shock from -40°C to +125°C with 15 minute soaks (IEC 68-2-4) | |
| High Temperature Storage | +105°C environment for 1,000 hours (IEC 68-2-2 Test Ba) | |
| Low Temperature Storage | -40°C environment for 1,000 hours (IEC 68-2-1 Test Aa) | |
| High Temperature Bias | +105°C environment while under bias for 1,000 hours (IEC 68-2-2 Test Ba) | |
| Low Temperature Bias | -40°C environment while under bias for 1,000 hours (IEC 68-2-1 Test Aa) | |
| Temperature/Humidity Bias | +85°C/85% R.H. environment while under bias for 1,000 hours (JESD22-A101A-B) | |
| Vibration | 12 minutes in each X, Y, Z axis from 20 to 2,000 Hz with peak acceleration of 20 G (MIL 883E, Method 2007.2,A) | |
| ESD-HBM | 3 discharges at ±2kV direct contact to I/O pins (ESD STM5.2) | |
| ESD-LID/GND | 3 discharges at ±8kV direct contact to lid when unit is grounded (IEC 61000-4-2) | |
| ESD-MM | 3 discharges at ±200V direct contact to IO pins (MIL 883E, Method 3015.7) | |
| Reflow | 5 reflow cycles with peak temperature of +260°C | |
| Mechanical Shock | 3 pulses of 10,000 G in each of the X, Y, and Z directions (IEC 68-2-27 Test Ea) | |

NOTES:

Microphones meet all acoustic and electrical specifications before and after reliability testing, except sensitivity which can deviate up to 3dB. After 3 reflow cycles, the sensitivity of the microphones shall not deviate more than 1 dB from its initial value.





SPECIFICATION REVISIONS

| Revision | Specification Changes | Date |
|----------|---|----------|
| A | Initial Release (ECR 16-955) | 6/24/16 |
| В | Corrected Idd(max) in Sleep Mode, Tdd(max); clarified center to edge tolerance; reliability clarification; reduced can X/Y tolerance to 0.045mm (ECR 16-1247) | 10/26/16 |
| С | Updated Carrier Tape (ECR 17-1928) | 9/28/17 |
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